

PS9822-1,-2

1 Mbps OPEN COLLECTOR OUTPUT TYPE 8-PIN SSOP (SO-8) HIGH-SPEED PHOTOCOUPLER R08DS0262EJ0100 Rev.1.00 Dec 22, 2021

DESCRIPTION

The PS9822-1 and PS9822-2 are active-low type high-speed photocouplers that use an AlGaAs light-emitting diode on the input side and a photodetector IC that includes a photodiode and a signal processor on the same chip on the output side.

The PS9822-1, -2 are high-speed digital output type photocouplers designed specifically for low circuit current. The PS9822-2 is suitable for high density applications.

FEATURES

Supply Voltage
 N rank: Vcc = 3.3 V
 L rank: Vcc = 5 V

- Pulse width distortion (| tphl-tplh | = 200 ns MAX.)
- 40% reduction of mounting area (5-pin SOP × 2)
- High-speed (1 Mbps)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Open collector output
- Ordering number of tape product: PS9822-1-F3: 1 500 pcs/reel

• : PS9822-2-F3 : 1 500 pcs/reel

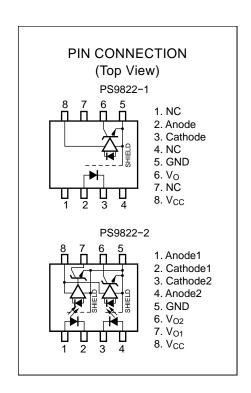
Pb-Free product

Safety standards
 UL : UL1577, Single protection

• VDE : DIN EN 60747-5-5 (Option)

APPLICATIONS

- PoE (Power over Ethernet)
- · Measurement equipment
- FA Network

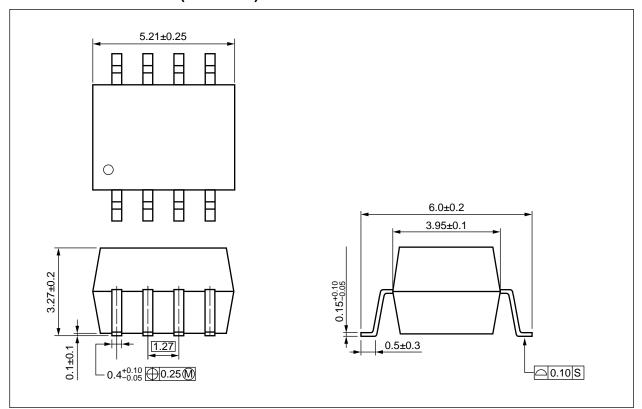


TRUTH TABLE

LED	Output
ON	L
OFF	Н

Start of mass production Oct.2008

PACKAGE DIMENSIONS (UNIT: mm)



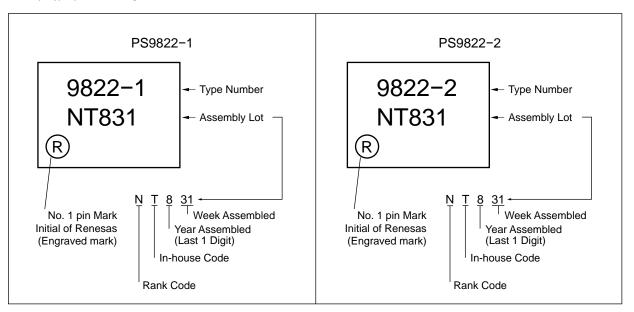
Weight: 0.14g (typ.)

PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	4 mm
Creepage Distance	4 mm
Isolation Distance	0.2 mm

MARKING EXAMPLE

Ni/Pd/Au PLATING



ORDERING INFORMATION

Part Number	Order Number*4	Rank	Solder Plating Specification	Packing Style	Safety Standards Approval	Application Part Number *1
PS9822-1	PS9822-1-AX	N*2	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9822-1
		L*3	(Ni/Pd/Au)		(UL, approved)	
PS9822-1-F3	PS9822-1-F3-AX	N*2		Embossed Tape 1 500 pcs/reel		
		L*3				
PS9822-2	PS9822-2-AX	N*2		20 pcs (Tape 20 pcs cut)		PS9822-2
		L*3				
PS9822-2-F3	PS9822-2-F3-AX	N*2		Embossed Tape 1 500 pcs/reel		
		L*3				
PS9822-1-V	PS9822-1-V-AX	N*2		20 pcs (Tape 20 pcs cut)	UL,	PS9822-1
		L*3			DIN EN 60747-5-5	
PS9822-1-V-F3	PS9822-1-V-F3-AX	N*2		Embossed Tape 1 500 pcs/reel	approved	
		L*3				
PS9822-2-V	PS9822-2-V-AX	N*2		20 pcs (Tape 20 pcs cut)		PS9822-2
		L*3				
PS9822-2-V-F3	PS9822-2-V-F3-AX	N*2		Embossed Tape 1 500 pcs/reel		
		L*3				

Notes*: 1. For the application of the Safety Standard, following part number should be used.

N rank: Vcc = 3.3 V
 L rank: Vcc = 5 V

4. When specifying rank, please add "/rank" after Order Number.

ex. N rank: PS9822-1-AX/N

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Cymhol	Rat	Unit	
		Symbol	PS9822-1	PS9822-1 PS9822-2	
Diode	Forward Current	lF	20 ^{*1}	15 ^{*2}	mA
	Reverse Voltage	VR	;	5	V/ch
Detector	Supply Voltage	Vcc	7		V
	Output Voltage	Vo	7 20 40		V/ch
	Output Current	lo			mA/ch
	Power Dissipation *3	Pc			mW/ch
Isolation V	oltage *4	BV	2.5	500	Vr.m.s.
Operating	Ambient Temperature	TA	- 40 to	+ 100	°C
Storage Te	emperature	T _{stg}	- 55 to + 125		°C

Notes*: 1. Reduced to 0.38 mA/ $^{\circ}$ C at T_A = 80 $^{\circ}$ C or more.

- 2. Reduced to 0.13 mA/ $^{\circ}$ C at T_A = 80 $^{\circ}$ C or more.
- 3. Applies to output pin Vo (collector pin). Reduced to 1.5 mW/ $^{\circ}$ C at T_A = 80 $^{\circ}$ C or more.
- 4. AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output. Pins 1-4 shorted together, 5-8 shorted together.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	
Low Level Input Voltage		V _{FL}	0		0.8	V
High Level Input Current		I _{FH}	6.3	10	12.5	mA
Supply Voltage	N rank	Vcc	2.7	3.3	3.6	V
	L rank		4.5	5.0	5.5	
Pull-up Resistance		RL	330		4 k	Ω
TLL ($R_L = 1.0 \text{ k}\Omega$, loads	s)	N			3	

ELECTRICAL CHARACTERISTICS : N rank ($T_A = -40 \text{ to } +100 \text{ °C}$, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, TA = 25 °C		1.6	1.8	V
	Reverse Current	lr	VR = 3 V, TA = 25 °C			10	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25 °C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 3.3 V, V _F = 0.8 V		1	100	μА
	Low Level Output Voltage*2	Vol	Vcc = 3.3 V, I _F = 5 mA, I _{OL} = 10 mA		0.2	0.6	٧
	High Level Supply Current (PS9822-1)	Іссн	Vcc = 3.3 V, I _F = 0 mA, Vo = Open			2	mA
	High Level Supply Current (PS9822-2)					4	
	Low Level Supply Current (PS9822-1)	Iccl	Vcc = 3.3 V, I _F = 10 mA, Vo = Open			3	
	Low Level Supply Current (PS9822-2)					6	
Coupled	Threshold Input Current $(H \rightarrow L)$	IFHL	$Vcc = 3.3 \text{ V}, Vo = 0.8 \text{ V}, RL = 350 \Omega$		2	5	mA
	Isolation Resistance	Ri-o	V _{I-O} = 1 kV _{DC} , RH = 40 to 60 %, T _A = 25 °C	10 ¹¹			Ω
	Isolation Capacitance	Cı-o	V = 0 V, f = 1 MHz, T _A = 25 °C		0.6		pF
	Propagation Delay Time $(H \rightarrow L)^{*3}$	t PHL	$\label{eq:Vcc} \begin{aligned} \text{Vcc} &= 3.3 \text{ V, RL} = 350 \ \Omega, \text{ If} = 7.5 \text{ mA}, \\ \text{VthhL} &= \text{VthLH} = 1.5 \text{ V} \end{aligned}$			500	ns
	Propagation Delay Time $(L \rightarrow H)^{*3}$	tрLН				700	
	Pulse Width Distortion (PWD) *3	tphl-tplh				200	
	Rise Time	tr			60		
	Fall Time	t f			70		
	Common Mode Transient Immunity at High Level Output ¹⁴	СМн	$V_{\text{CC}} = 3.3 \text{ V, R}_{\text{L}} = 350 \ \Omega, \ T_{\text{A}} = 25 \ ^{\circ}\text{C},$ $I_{\text{F}} = 0 \ \text{mA, Vo} > 2 \ \text{V, V}_{\text{CM}} = 1 \ \text{kV}$	15	20		kV/μs
	Common Mode Transient Immunity at Low Level Output* ⁴	CML	$Vcc = 3.3 \text{ V}, R_L = 350 \Omega, T_A = 25 °C,$ $I_F = 7.5 \text{ mA}, Vo < 0.8 \text{ V}, VcM = 1 \text{ kV}$	15	20		

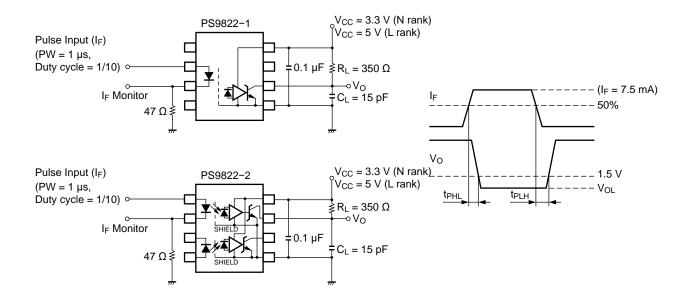
ELECTRICAL CHARACTERISTICS: L rank (TA = -40 to +100 °C, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP.*⁵	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, T _A = 25 °C		1.6	1.8	V
	Reverse Current	IR	V _R = 3 V, T _A = 25 °C			10	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25 °C		30		pF
Detector	High Level Output Current	Іон	Vcc = Vo = 5 V, V _F = 0.8 V		1	100	μА
	Low Level Output Voltage ^{*6}	Vol	Vcc = 5 V, IF = 5 mA, IoL = 13 mA		0.2	0.6	V
	High Level Supply Current (PS9822-1)	Іссн	Vcc = 5 V, I _F = 0 mA, Vo = Open			2.5	mA
	High Level Supply Current (PS9822-2)					5	
	Low Level Supply Current (PS9822-1)	Iccl	Vcc = 5 V, I _F = 10 mA, Vo = Open			3.5	
	Low Level Supply Current (PS9822-2)					7	
Coupled	Threshold Input Current $(H \rightarrow L)$	IFHL	$Vcc = 5 \text{ V}, Vo = 0.8 \text{ V}, RL = 350 \Omega$		2	5	mA
	Isolation Resistance	Rı-o	VI-0 = 1 kVDC, RH = 40 to 60 %, TA = 25 °C	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz, T _A = 25 °C		0.6		pF
	Propagation Delay Time $(H \rightarrow L)^{*7}$	t _{PHL}	$\label{eq:Vcc} \begin{aligned} &\text{Vcc} = 5 \text{ V, } \text{RL} = 350 \Omega \text{, } \text{If} = 7.5 \text{ mA,} \\ &\text{VTHHL} = \text{VTHLH} = 1.5 \text{ V} \end{aligned}$			500	ns
	Propagation Delay Time $(L \rightarrow H)^{*7}$	t PLH				700	
	Pulse Width Distortion (PWD)*7	tphl-tplh				200	
	Rise Time	t _r			60		
	Fall Time	tf			70		
	Common Mode Transient Immunity at High Level Output*8	СМн	$V_{CC} = 5 \text{ V}, \text{ R}_L = 350 \ \Omega, \text{ T}_A = 25 \ ^{\circ}\text{C},$ $I_F = 0 \text{ mA}, \text{ V}_O > 2 \text{ V}, \text{ V}_{CM} = 1 \text{ kV}$	15	20		kV/μs
	Common Mode Transient Immunity at Low Level Output ^{*8}	CM∟	$Vcc = 5 \text{ V}, \text{ R}_L = 350 \Omega, \text{ T}_A = 25 ^{\circ}\text{C},$ $I_F = 7.5 \text{ mA}, \text{ Vo} < 0.8 \text{ V}, \text{ VcM} = 1 \text{ kV}$	15	20		

Notes*: 1, 5. Typical values at T_A = 25 °C

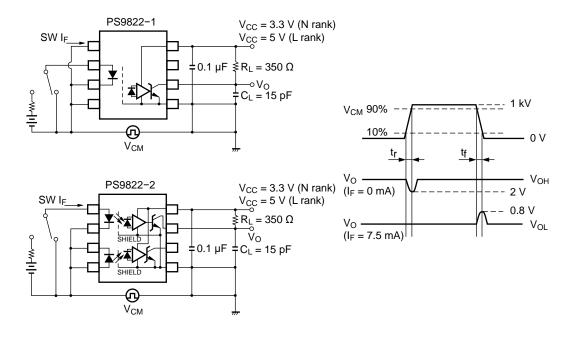
2, 6. Because V_{OL} of 2 V or more may be output when LED current input and when output supply of $V_{CC} = 2.6$ V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.

3, 7. Test circuit for propagation delay time.



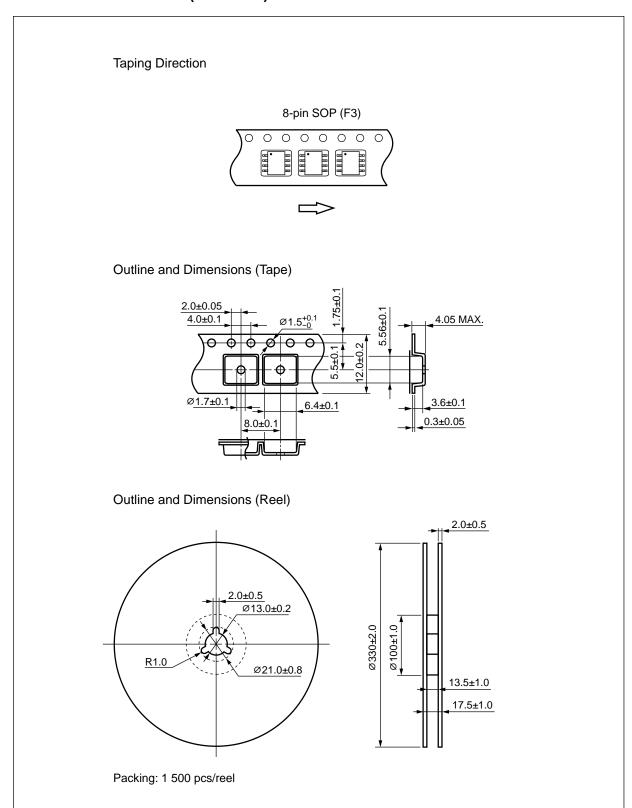
Remark: C_L includes probe and stray wiring capacitance.

4, 8. Test circuit for common mode transient immunity

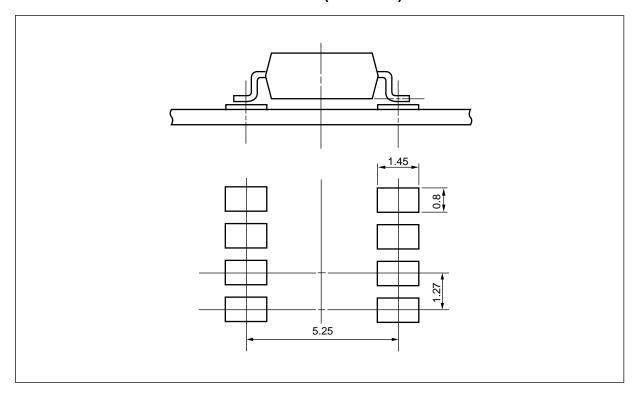


Remark: C_L includes probe and stray wiring capacitance.

TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

 Peak reflow temperature 260 °C or below (package surface temperature)

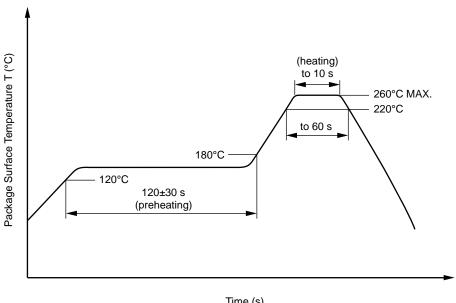
 Time of peak reflow temperature 10 seconds or less Time of temperature higher than 220 °C 60 seconds or less

• Time to preheat temperature from 120 to 180 °C $\,$ 120 \pm 30 s

Number of reflows

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260 °C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120 °C or below (package surface temperature)

One (Allowed to be dipped in solder including plastic mold portion.) Number of times • Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

 Peak Temperature (lead part temperature) 350 °C or below Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100 °C

(4) Cautions

Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

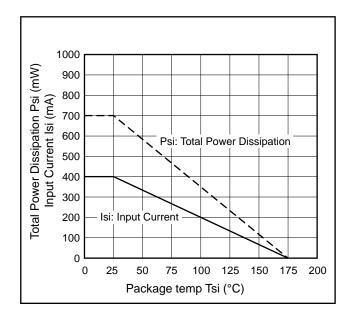
USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.
- 4. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 5. Do not use fixing agents or coatings containing halogen-based substances.

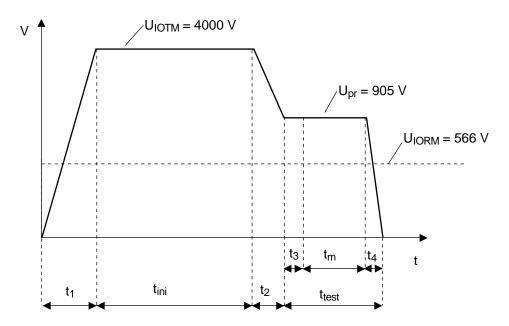
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/100/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	566	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	U_pr	849	V_{peak}
$U_{pr} = 1.6 \times U_{IORM.}, P_d < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	U_pr	1 061	V_{peak}
$U_{pr} = 1.875 \times U_{IORM.}, P_d < 5 pC$			
Highest permissible overvoltage	U _{ЮТМ}	4 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T_{stg}	- 55 to +125	°C
Operating temperature range	TA	- 40 to +100	ç
Isolation resistance, minimum value			
V_{IO} = 500 V dc at T_A = 25 °C	Ris MIN.	10 ¹²	Ω
V _{IO} = 500 V dc at T _A MAX. at least 100 °C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	150	°C
Current (input current I _F , Psi = 0)	Isi	150	mA
Power (output or total power dissipation)	Psi	600	mW
Isolation resistance			
$V_{IO} = 500 \text{ V dc at } T_A = Tsi$	Ris MIN.	10 ⁹	Ω

Dependence of maximum safety ratings with package temperature



Method a) Destructive Test, Type and Sample Test



 t_1 , $t_2 = 1$ to 10 sec

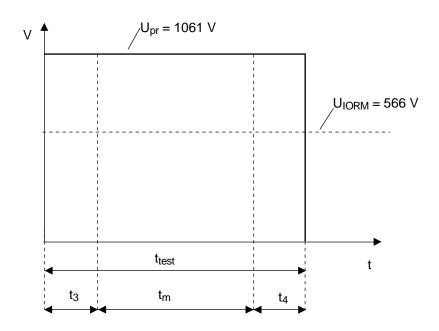
 t_3 , $t_4 = 1$ sec

 $t_{\text{m(PARTIAL DISCHARGE)}} = 10 \text{ sec}$

 $t_{test} = 12 sec$

 $t_{\text{ini}} = 60 \text{ sec}$

Method b) Non-destructive Test, 100% Production Test



 t_3 , $t_4 = 0.1 \text{ sec}$

 $t_{\text{m(PARTIAL DISCHARGE)}} = 1.0 \text{ sec}$

 $t_{test} = 1.2 \text{ sec}$

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or i any way allow it to enter the mouth.

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